

Description

The 74HCT164 is a serial input 8-bit edge-triggered shift register that has outputs from each of eight stages.

SERIAL DATA INPUT PINS

The serial input data is entered at pin SDA or pin SDB as these are logically ANDED. Either input could be used as an active HIGH enable with data entry on the other pin. If a single input is desired, the pins can be tied together or the unused input can be tied HIGH.

DATA ENTRY

Data is shifted into Q0 from the serial input pins on each LOW to HIGH transition of the CP pin. Also during the CP edge the data is transferred from each Qn to Qn+1. The serial data on pins SDA and SDB must be stable before and after the CP rising edge to meet the set-up and hold timing requirements.

RESET

When asserted LOW the Master Reset (\overline{MR}) pin sets all Qn to LOW. This action does not depend on the condition of serial input or clock pins. The \overline{MR} must be asserted HIGH for a recovery time before the next CP positive edge pulse.

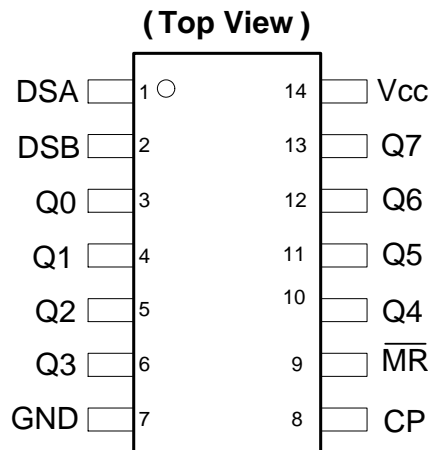
Features

- Supply Voltage Range from 4.5V to 5.5V
- Sinks or Sources 4mA at $V_{CC} = 4.5V$
- CMOS Low Power Consumption
- Schmitt Trigger Action at All Inputs
- TTL Compatible
- ESD Protection Exceeds JESD 22
 - 200-V Machine Model (A115)
 - 2000-V Human Body Model (A114)
 - Exceeds 1000-V Charged Device Model (C101)
- Range of Package Options SO-14 and TSSOP-14
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Pin Assignments



SO-14 / TSSOP-14 / PDIP-14*

*PDIP-14 is a future product

Applications

- General Purpose Logic
- Wide Array of Products Such as:
 - PCs, Networking, Notebooks, Netbooks
 - Computer Peripherals, Hard Drives, CD/DVD ROM
 - TV, DVD, DVR, Set-Top Box

Device ordering information is on page 7

Pin Descriptions

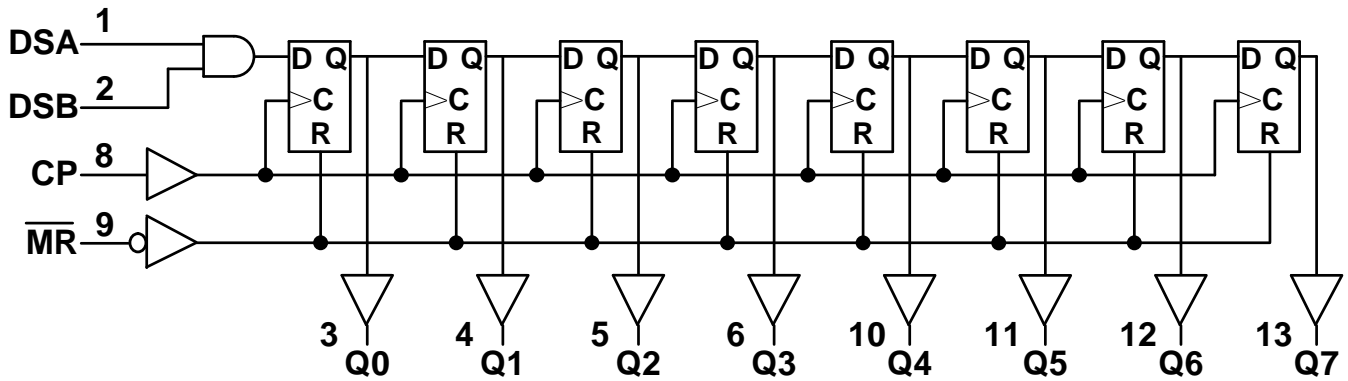
| Pin Number | Pin Name | Function |
|------------|------------------------|--------------------------------------|
| 1 | DSA | Serial Data Input |
| 2 | DSB | Serial Data Input |
| 3 | Q0 | Data Output |
| 4 | Q1 | Data Output |
| 5 | Q2 | Data Output |
| 6 | Q3 | Data Output |
| 7 | GND | Ground |
| 8 | CP | Clock Pulse –Positive Edge Triggered |
| 9 | $\overline{\text{MR}}$ | Master Reset - Asynchronous |
| 10 | Q4 | Data Output |
| 11 | Q5 | Data Output |
| 12 | Q6 | Data Output |
| 13 | Q7 | Data Output |
| 14 | V _{CC} | Supply Voltage |

Function Table

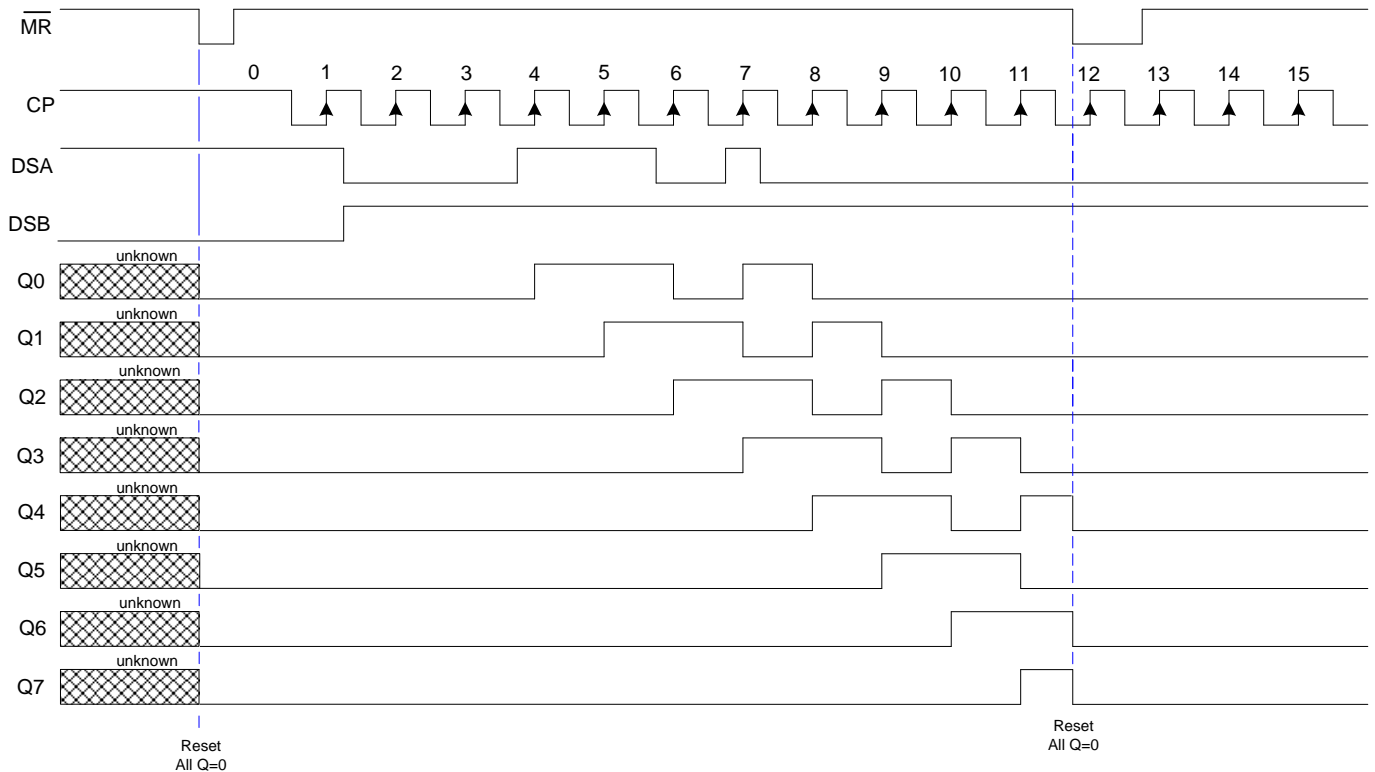
| Mode | Input | | | | Output | |
|-------|------------------------|----|-----|-----|--------|---|
| | $\overline{\text{MR}}$ | CP | DSA | DSB | Q0 | Q1-Q7 |
| Reset | L | X | X | X | L | L |
| Shift | H | ↑ | L | X | L | Q _n ←Q _{n-1} (n= 1 to7) |
| | H | ↑ | X | L | L | Q _n ←Q _{n-1} (n= 1 to7) |
| | H | ↑ | H | H | H | Q _n ←Q _{n-1} (n= 1 to7) |

Note: 4. Signals asserted on DSA and DSB must be in place longer than T_{su} (set up time) before CP occurs and remain in place Thold (hold time) after CP.

Logic Diagram



Timing Diagram



- Notes:
5. All Q values are reset to LOW when \overline{MR} goes low. \overline{MR} is asynchronous and overrides all other signals.
 6. Serial data supplied at DSA and DSB is ANDED and transferred to Q0 on positive edge of CP.

Absolute Maximum Ratings (Note 7) ($T_A = +25^\circ\text{C}$, unless otherwise specified.)

| Symbol | Description | Rating | Unit |
|-----------|---|--------------|------------------|
| ESD HBM | Human Body Model ESD Protection | 2 | kV |
| ESD CDM | Charged Device Model ESD Protection | 1 | kV |
| ESD MM | Machine Model ESD Protection | 200 | V |
| V_{CC} | Supply Voltage Range | -0.5 to +7.0 | V |
| V_I | Input Voltage Range (Note 8) | -0.5 to +7.0 | V |
| I_{IK} | Input Clamp Current $V_I < -0.5\text{V}$ or $V_I > V_{CC} + 0.5\text{V}$ | ± 20 | mA |
| I_{OK} | Output Clamp Current $V_O < -0.5\text{V}$ or $V_O > V_{CC} + 0.5\text{V}$ | ± 20 | mA |
| I_O | Continuous Output Current $-0.5\text{V} < V_O < V_{CC} + 0.5\text{V}$ | ± 25 | mA |
| I_{CC} | Continuous Current Through V_{CC} | 50 | mA |
| I_{GND} | Continuous Current Through GND | -50 | mA |
| T_J | Operating Junction Temperature | -40 to +150 | $^\circ\text{C}$ |
| T_{STG} | Storage Temperature | -65 to +150 | $^\circ\text{C}$ |
| P_{TOT} | Total Power Dissipation | 500 | mW |

Notes: 7. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.
8. Input Voltage cannot exceed V_{CC} to the extent the Maximum clamp current is exceeded.

Recommended Operating Conditions (Note 9) ($T_A = +25^\circ\text{C}$, unless otherwise specified.)

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---------------------|------------------------------------|------------------------|-----|----------|------------------|
| V_{CC} | Supply Voltage | - | 4.5 | 5.5 | V |
| V_I | Input Voltage | - | 0 | V_{CC} | V |
| V_O | Output Voltage | - | 0 | V_{CC} | V |
| $\Delta t/\Delta V$ | Input transition rise or fall rate | $V_{CC} = 4.5\text{V}$ | - | 140 | ns/V |
| T_A | Operating Free-Air Temperature | - | -40 | +125 | $^\circ\text{C}$ |

Note: 9. Unused inputs should be held at V_{CC} or Ground.

Electrical Characteristics ($T_A = +25^\circ\text{C}$, unless otherwise specified.)

| Symbol | Parameter | Test Conditions | V_{CC} | $T_A = +25^\circ\text{C}$ | | | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ | | $T_A = -40^\circ\text{C} \text{ to } +125^\circ\text{C}$ | | Unit |
|-----------------|---------------------------|---|--------------|---------------------------|------|-----------|---|---------|--|---------|---------------|
| | | | | Min. | Typ. | Max. | Min. | Max. | Min. | Max. | |
| V_{IH} | High-Level Input Voltage | - | 4.5V to 5.5V | 2.0 | 1.6 | - | 2.0 | - | 2.0 | - | V |
| V_{IL} | Low-level Input Voltage | - | 4.5V to 5.5V | - | 1.2 | 0.8 | - | 0.8 | - | 0.8 | V |
| V_{OH} | High-level Output Voltage | $I_{OH} = -20\mu\text{A}$ | 4.5V | 4.4 | 4.5 | - | 4.4 | - | 4.4 | - | V |
| | | $I_{OH} = -4.0\text{mA}$ | 4.5V | 3.98 | 4.32 | - | 3.84 | - | 3.7 | - | V |
| V_{OL} | Low-level Output Voltage | $I_{OL} = 20\mu\text{A}$ | 4.5V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | $I_{OL} = 4\text{mA}$ | 4.5V | - | 0.15 | 0.26 | - | 0.33 | - | 0.4 | V |
| I_I | Input Current | $V_I = \text{GND or } V_{CC}$ | 6.0V | - | - | ± 0.1 | - | ± 1 | - | ± 1 | μA |
| I_{CC} | Supply Current | $V_I = \text{GND or } V_{CC}, I_O = 0$ | 6.0V | - | - | 8.0 | - | 80 | - | 160 | μA |
| ΔI_{CC} | Additional Supply current | $V_I = V_{CC} - 2.1\text{V}$ $I_O = 0$ Other inputs at V_{CC} or GND. | 4.5V to 5.5V | - | 100 | 360 | - | 450 | - | 490 | μA |

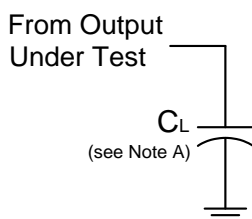
Switching Characteristics

| Symbol / Parameter | Pins | Test Conditions | V _{CC} | T _A =25°C | | | -40°C to 85°C | | -40°C to 125°C | | Unit |
|--|------------------------------|-----------------|-----------------|----------------------|------|-----|---------------|-----|----------------|-----|------|
| | | | | Min | Typ. | Max | Min | Max | Min | Max | |
| f _{MAX} Maximum | CP | Figure 1 | 4.5V | 27 | 55 | - | 22 | - | 18 | - | MHz |
| | | | 5.0V | - | 61 | - | - | - | - | - | |
| t _w Pulse Width | CP HIGH or LOW | Figure 1 | 4.5V | 18 | 7 | - | 23 | - | 27 | - | ns |
| | $\overline{\text{MR}}$ LOW | Figure 1 | 4.5V | 18 | 10 | - | 23 | - | 27 | - | ns |
| t _{SU} Set-up Time | DSA or DSB to CP | Figure 1 | 4.5V | 12 | 6 | - | 15 | - | 18 | - | ns |
| t _H Hold Time | DSA or DSB to CP | Figure 1 | 4.5V | 4 | -2 | - | 4 | - | 4 | - | ns |
| t _{rec} Recovery Time | $\overline{\text{MR}}$ to CP | Figure 1 | 4.5V | 16 | 7 | - | 20 | - | 24 | - | ns- |
| t _{PD} Propagation | CP to Qn | Figure 1 | 4.5V | - | 17 | 36 | - | 45 | - | 54 | ns |
| | | | 5.0V | - | 14 | - | - | - | - | - | |
| t _{PHL} HIGH to LOW Propagation | $\overline{\text{MR}}$ to Qn | Figure 1 | 4.5V | - | 19 | 38 | - | 48 | - | 57 | ns |
| | | | 5.0V | - | 16 | - | - | - | - | - | |
| t _T Transition Time | All Signals | Figure 1 | 4.5V | - | 7 | 15 | - | 19 | - | 22 | ns |

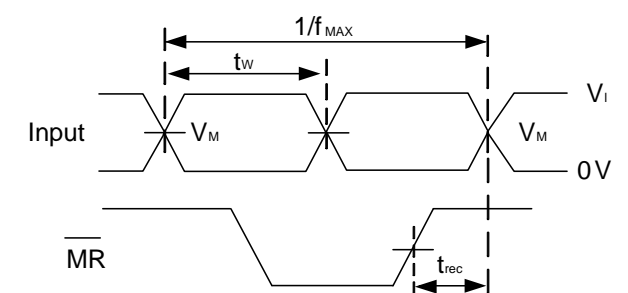
Operating Characteristics (T_A = +25°C, unless otherwise specified.)

| Parameter | | Test Conditions | V _{CC} = 6V | Unit |
|-----------------|--|---|----------------------|------|
| | | | Typ | |
| C _{pd} | Power Dissipation Capacitance per Gate | f = 1 MHz V _I = Gnd to V _{CC} -1.5V | 40 | pF |
| C _I | Input Capacitance | V _I = Gnd or V _{CC} | 3.5 | pF |

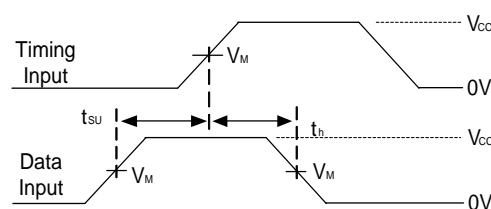
Parameter Measurement Information



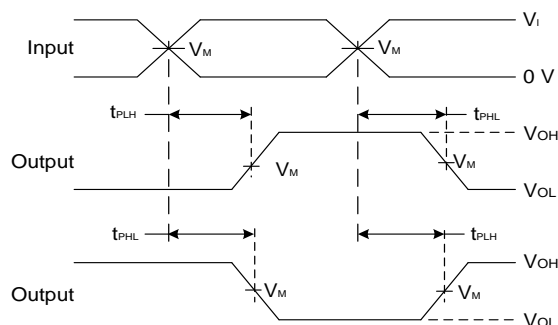
| V_{CC} | Inputs | | V_M | C_L |
|----------|----------|-----------|-------|-------|
| | V_I | t_r/t_f | | |
| 4.5V | V_{CC} | 6ns | 1.3V | 50pF |
| 5.0V | V_{CC} | 6ns | 1.3V | 15pF |



**Voltage Waveform
Pulse Duration and Recovery Time**



**Voltage Waveform
Set-up and Hold Times**

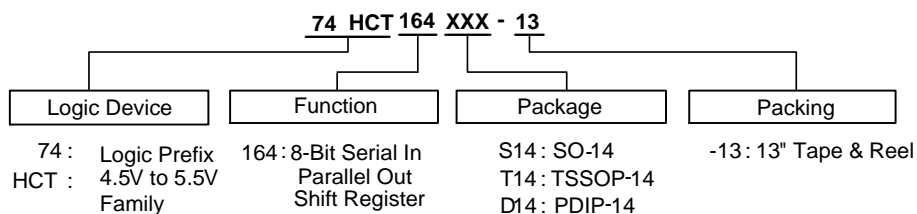


**Voltage Waveform
Propagation Delay Times
Inverting and Non Inverting Outputs**

- Notes:
- A . Includes test lead and test apparatus capacitance.
 - B. All pulses are supplied at pulse repetition rate ≤ 10 MHz
 - C. Inputs are measured separately one transition per measurement
 - D. t_{PLH} and t_{PHL} are the same as t_{PD}
 - E. Transition times t_r , t_{fH} , t_{fL} are measured from the 10% to 90% or 90% to 10% of the appropriate waveform.

Figure 1 Load Circuit and Voltage Waveforms

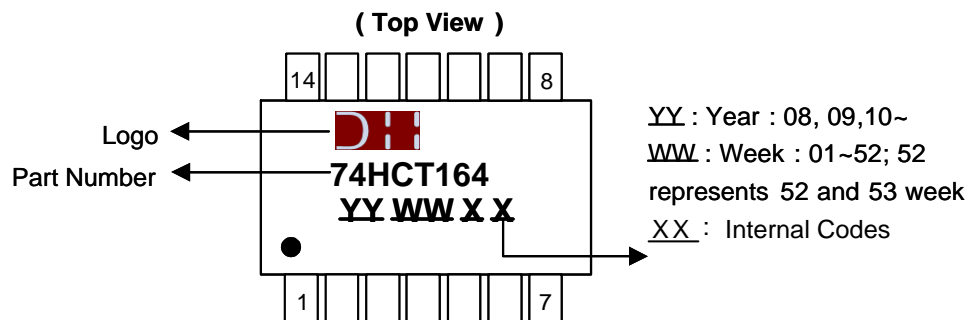
Ordering Information



| Device | Package Code | Packaging | Packing | |
|-------------------------------|--------------|-----------|------------------|--------------------|
| | | | Quantity | Part Number Suffix |
| 74HCT164S14-13 | S14 | SO-14 | 2500/Tape & Reel | -13 |
| 74HCT164T14-13 | T14 | TSSOP-14 | 2500/Tape & Reel | -13 |
| 74HCT164D14 Future Product | D14 | PDIP-14 | Tube | - |

Marking Information

(1) SO-14, TSSOP-14, PDIP-14

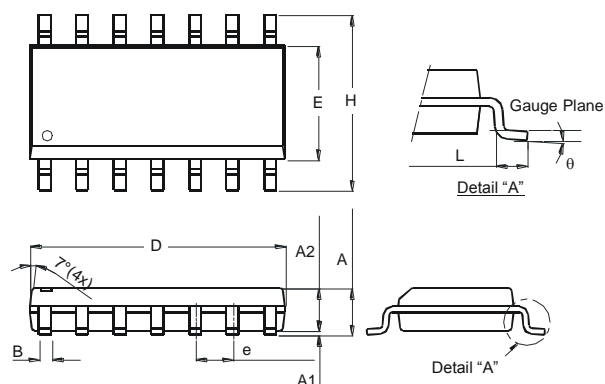


| Part Number | Package |
|----------------|----------|
| 74HCT164S14-13 | SO-14 |
| 74HCT164T14-13 | TSSOP-14 |
| 74HCT164D14 | PDIP-14 |

Package Outline Dimensions (All dimensions in mm.)

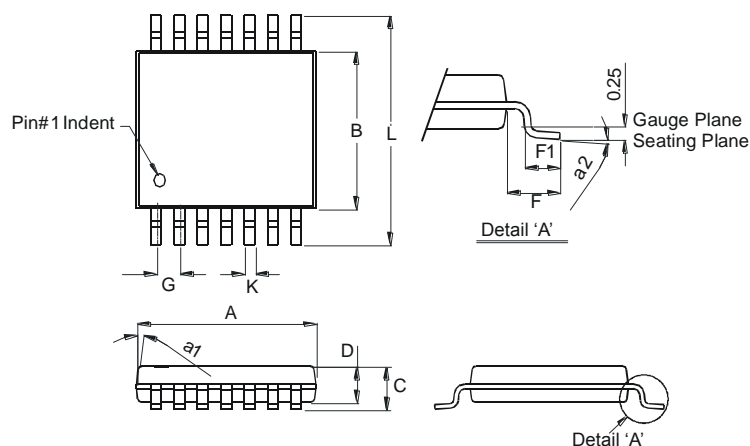
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.

Package Type: SO-14



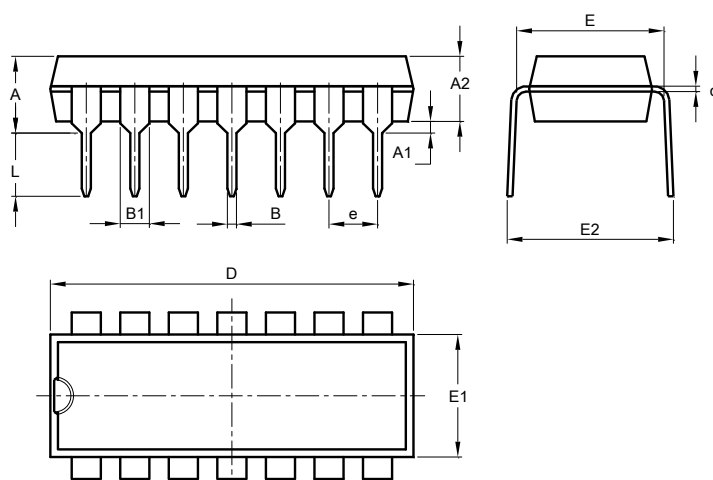
| SO-14 | | |
|----------------------|----------|------|
| Dim | Min | Max |
| A | 1.47 | 1.73 |
| A1 | 0.10 | 0.25 |
| A2 | 1.45 Typ | |
| B | 0.33 | 0.51 |
| D | 8.53 | 8.74 |
| E | 3.80 | 3.99 |
| e | 1.27 Typ | |
| H | 5.80 | 6.20 |
| L | 0.38 | 1.27 |
| θ | 0° | 8° |
| All Dimensions in mm | | |

Package Type: TSSOP-14



| TSSOP-14 | | |
|----------------------|----------|------|
| Dim | Min | Max |
| a1 | 7° (4X) | |
| a2 | 0° | 8° |
| A | 4.9 | 5.10 |
| B | 4.30 | 4.50 |
| C | — | 1.2 |
| D | 0.8 | 1.05 |
| F | 1.00 Typ | |
| F1 | 0.45 | 0.75 |
| G | 0.65 Typ | |
| K | 0.19 | 0.30 |
| L | 6.40 Typ | |
| All Dimensions in mm | | |

Package Type: PDIP-14

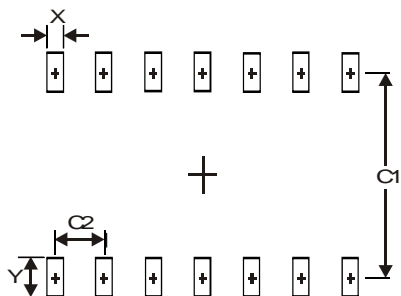


| PDIP-14 | | |
|----------------------|-------------|--------|
| Dim | Min | Max |
| A | 3.710 | 4.310 |
| A1 | 0.510 | - |
| A2 | 3.200 | 3.600 |
| B | 0.380 | 0.570 |
| B1 | 1.524 (BSC) | |
| c | 0.204 | 0.360 |
| D | 18.800 | 19.200 |
| E | 6.200 | 6.600 |
| E1 | 7.320 | 7.920 |
| E2 | 8.400 | 9.000 |
| e | 2.540 (BSC) | |
| L | 3.000 | 3.600 |
| All Dimensions in mm | | |

Suggested Pad Layout

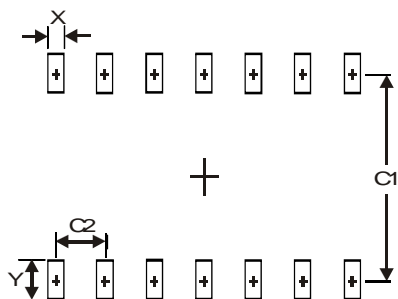
Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for latest version.

Package Type: SO-14



| Dimensions | Value (in mm) |
|------------|---------------|
| X | 0.60 |
| Y | 1.50 |
| C1 | 5.4 |
| C2 | 1.27 |

Package Type: TSSOP-14



| Dimensions | Value (in mm) |
|------------|---------------|
| X | 0.45 |
| Y | 1.45 |
| C1 | 5.9 |
| C2 | 0.65 |

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